

Features

- Fast Switching Speed
- Small Surface Mount Package
- For General Purpose Switching Applications
- **Lead Free by Design/RoHS Compliant (Note 1)**
- **Halogen and Antimony Free "Green" Device (Notes 2 & 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound (Notes 2 & 3). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.006 grams (approximate)

SOD323



Top View

Ordering Information (Notes 4 & 5)

Part Number	Qualification	Case	Packaging
1N4148WS-7-F	Commercial	SOD323	3,000/Tape & Reel
1N4148WSQ-7-F	Automotive	SOD323	3,000/Tape & Reel
1N4148WS-13-F	Commercial	SOD323	10,000/Tape & Reel
BAV16WS-7-F	Commercial	SOD323	3,000/Tape & Reel

- Notes:
1. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead.
 2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 3. Diodes Inc.'s "Green" policy can be found on our website at <http://www.diodes.com>.
 4. Product manufactured with Date Code OW (week 42, 2009) and newer are built with Green Molding Compound. Product manufactured prior to Date Code OW are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.
 5. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



XX = Product Type Marking Code, T4 or T6

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage (Note 7)	V _{RM}	100	V	
Peak Repetitive Reverse Voltage	V _{RRM}	75	V	
Working Peak Reverse Voltage	V _{RWM}			
DC Blocking Voltage	V _R			
RMS Reverse Voltage	V _{R(RMS)}	53	V	
Forward Continuous Current	I _{FM}	300	mA	
Average Rectified Output Current	I _O	150	mA	
Non-Repetitive Peak Forward Surge Current	I _{FSM}	@ t = 1.0μs	2.0	A
		@ t = 1.0s	1.0	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	75	—	V	I _R = 1.0μA
Forward Voltage	V _{FM}	—	0.715	V	I _F = 1.0mA
			0.855		I _F = 10mA
			1.0		I _F = 50mA
			1.25		I _F = 150mA
Peak Reverse Current (Note 7)	I _{RM}	—	1.0	μA	V _R = 75V
			50		V _R = 75V, T _J = 150°C
			30		V _R = 25V, T _J = 150°C
			25		V _R = 20V
Total Capacitance	C _T	—	2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	4.0	ns	I _F = I _R = 10mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

- Notes: 6. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website <http://www.diodes.com>.
 7. Short duration pulse test used to minimize self-heating effect.

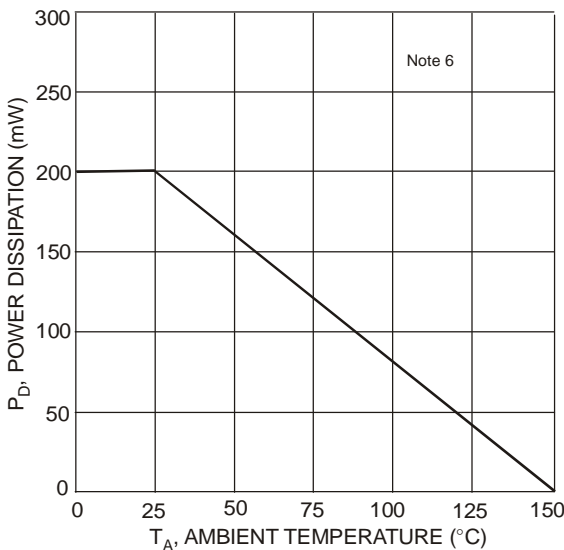


Fig. 1 Power Derating Curve

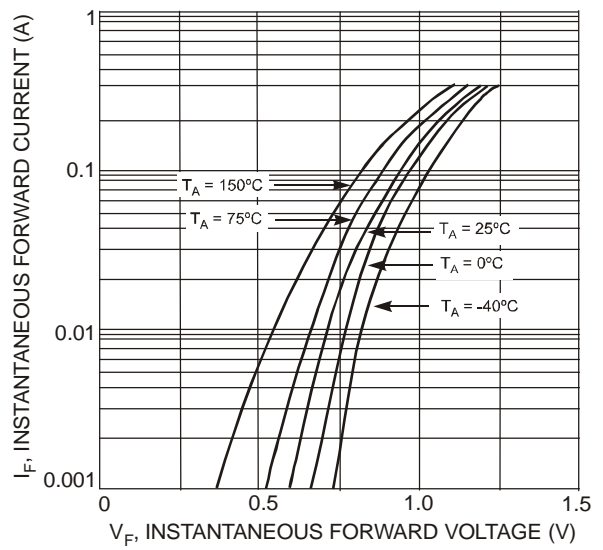


Fig. 2 Typical Forward Characteristics



Fig. 3 Typical Reverse Characteristics



Fig. 4 Typical Total Capacitance vs. Reverse Voltage



Fig. 5 Maximum Non-Repetitive Surge Current

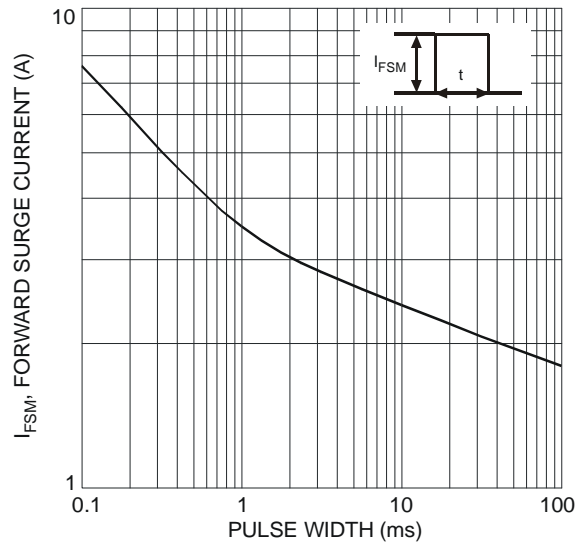


Fig. 6 Maximum Non-Repetitive Surge Current

Package Outline Dimensions



SOD323		
Dim	Min	Max
A	0.25	0.35
B	1.20	1.40
C	2.30	2.70
H	1.60	1.80
J	0.00	0.10
K	1.0	1.1
L	0.20	0.40
M	0.10	0.15
α	0°	8°

All Dimensions in mm

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.75
G	1.05
X	0.65
Y	1.35
C	2.40

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